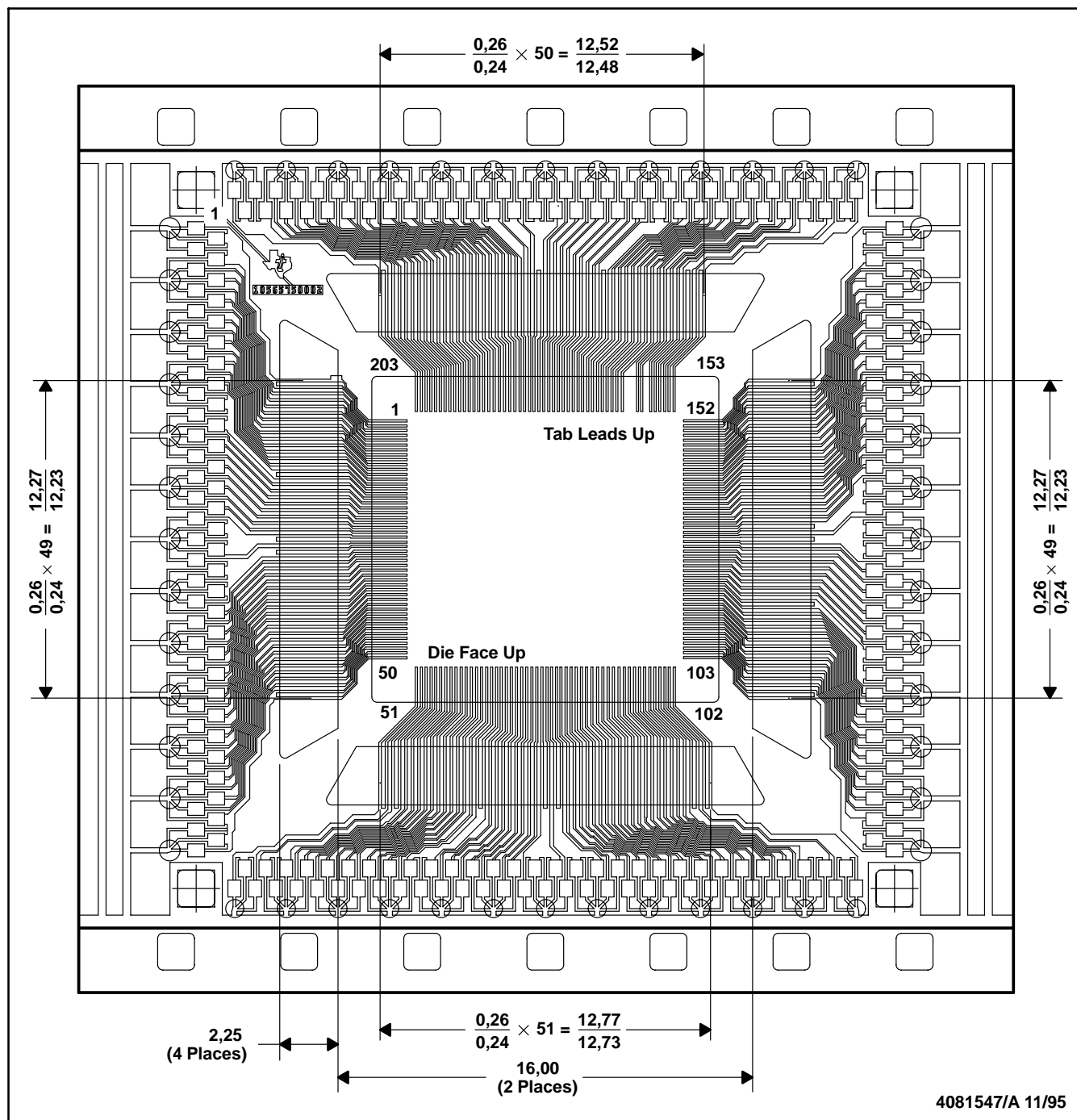


TB (S-MQCC-F203)
(35 OR 70 mm WITHOUT PROTECTIVE FILM)

SMJ320C30 244-PIN TAB FRAME (PG5) SOCKET,
203 OLB/ILB 0,25-mm OLB PITCH



- NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. The OLB lead width is $0,1016 \pm 0,02$ mm.
D. The ILB lead width is $0,0832 \pm 0,015$ mm.
E. The Tape width is 35 mm.
F. The TB is bare die.

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